

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Application of: Eric Stephen Carlsgaard

Examiner: Andy Huynh

Group Art: 2818

Serial No.: 10/502,506

Filed: July 23, 2004

For: Flip Chip Die Bond Pads, Die Bond Pad  
Placement and Routing Optimization

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**REQUEST FOR TWO MONTH EXTENSION OF TIME**

Hon. Commissioner of Patents  
and Trademarks  
Washington, D.C. 20231

S I R:

In response to the Office Action dated January 5, 2007, for which a shortened statutory period of three months ending April 5, 2007 was set in which to respond, a two-month extension, ending June 5, 2007 pursuant to 37 CFR 1.136(a) is hereby requested to keep this application pending.

Please charge the required fee of four hundred fifty dollars (\$450.00) for extending the time for a response within the second month after the original response date, pursuant to 37 CFR 1.17(b) to Deposit Account 07-0832

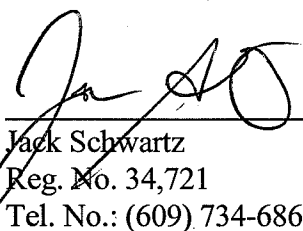
No additional fee is believed due with this request. However, should an additional

fee be due please charge the fee to Deposit Account No. 07-0832.

A Notice of Appeal is being filed with the request for two-month extension of time.  
In view the filing of this request for two-month extension of time, it is respectfully submitted  
that this Notice of Appeal is timely filed.

Respectfully submitted,  
Eric Stephen Caarlsgard

By:

  
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June 1, 2007